MOSFET - N-Channel QFET[®]

600 V, 3.4 Ω, 3.0 A

FQP3N60C

General Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 3.0 A, 600 V, $R_{DS(on)}$ = 3.4 Ω (Max.) at V_{GS} = 10 V, I_D = 1.5 A
- Low Gate Charge (Typ. 10.5 nC)
- Low C_{rss} (Typ. 5.0 pF)
- 100% Avalanche Tested
- This is a Pb–Free Device

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter		Ratings	Unit	
V _{DSS}	Drain-Source	Drain-Source Voltage		V	
V _{GSS}	Gate-Source V	/oltage	±30	V	
Ι _D	Drain Current Continuous ($T_C = 25^{\circ}C$)		3	А	
		Continuous (T _C = 100°C)	1.8		
I _{DM}	Drain Current	Pulsed (Note 1)	12	А	
E _{AS}	Single Pulse Avalanche Energy (Note 2)		150	mJ	
I _{AR}	Avalanche Current (Note 1)		3	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		7.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns	
P _D Power		(T _C = 25°C)	75	W	
	Dissipation	Derate above 25°C	0.62	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Repetitive rating: pulse-width limited by maximum junction temperature
- 2. L = 30 mH, I_{AS} = 3 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C
- 3. $I_{SD} \le$ 3 A, di/dt \le 200 A/µs, $V_{DD} \le$ BV_{DSS}, starting T_J = 25°C

THERMAL CHARACTERITICS

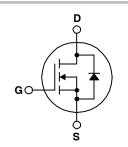
Symbol	Parameter	Ratings	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	1.67	°C/W
$R_{ heta JA}$	Maximum Thermal Resistance, Junction to Ambient	62.5	°C/W



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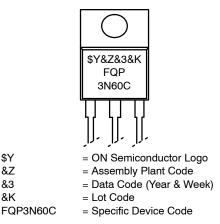
V _{DS}	R _{DS(ON)} MAX	I _D MAX
600 V	3.4 Ω @ 10 V	3.0 A



N-Channel MOSFET



MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
FQP3N60C	TO-220-3LD (Pb-Free)	50 Units/ Tube

June, 2021 - Rev. 6

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS	-	•	•	-	
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	600	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C	-	0.6	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
		V_{DS} = 480 V, T_{C} = 125 °C	-	-	10	1
I _{GSSF}	Gate -Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate -Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, \text{V}_{DS} = 0 \text{ V}$			-100	nA
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2.0	-	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V_{GS} = 10 V, I _D = 1.5 A	-	2.8	3.4	Ω
9 FS	Forward Transconductance	V _{DS} = 40 V, I _D = 1.5 A	-	3.5	-	S
OYNAMIC C	HARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	-	435	565	pF
C _{oss}	Output Capacitance	7	-	45	60	pF
C _{rss}	Reverse Transfer Capacitance		-	5	8	pF
WITCHING	CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 3 \text{ A},$	-	12	34	ns
t _r	Turn-On Rise Time	R _G = 25 Ω (Note 4)	-	30	70	ns
t _{d(off)}	Turn-Off Delay Time		-	35	80	ns
t _f	Turn-Off Fall Time	7	-	35	80	ns
Qg	Total Gate Charge	$V_{DS} = 480 \text{ V}, \text{ I}_{D} = 3 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	10.5	14	nC
Q _{gs}	Gate-Source Charge	— (Note 4) —	-	2.1	-	nC
Q _{gd}	Gate-Drain Charge		_	4.5	-	nC
RAIN-SOU	RCE DIODE CHARACTERISTICS AND M	AXIMUM RATINGS				
I _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	3	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	12	Α
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I _S = 3 A	-	-	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 3 \text{ A},$ $dI_{F}/dt = 100 \text{ A}/\mu\text{s}$	-	260	-	ns
Q _{rr}	Reverse Recovery Charge		_	1.6	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature.

TYPICAL PERFORMANCE CHARACTERISTICS

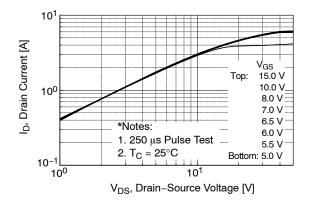


Figure 1. On-Region Characteristics

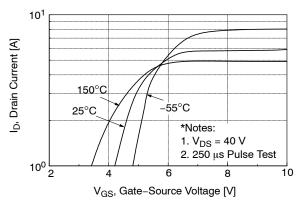


Figure 2. Transfer Characteristics

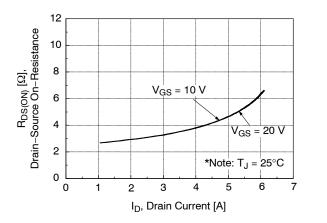


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

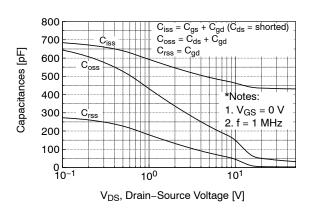
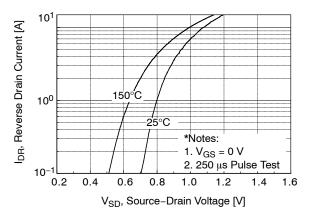
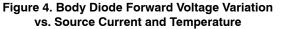


Figure 5. Capacitance Characteristics





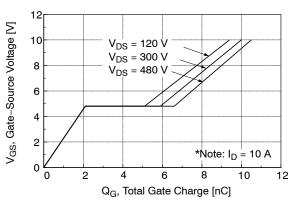
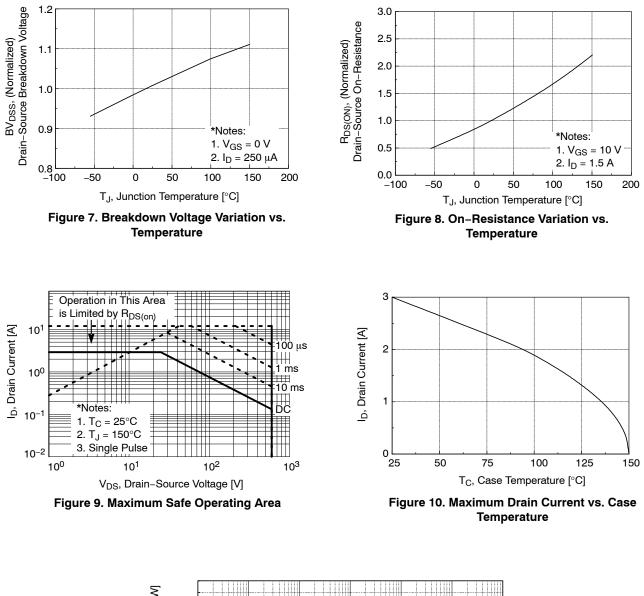


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS



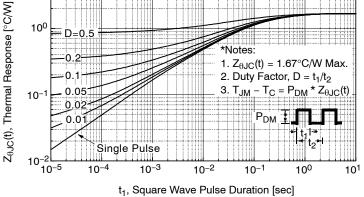


Figure 11. Transient Thermal Response Curve

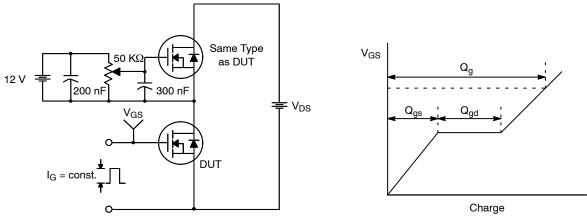


Figure 12. Gate Charge Test Circuit & Waveform

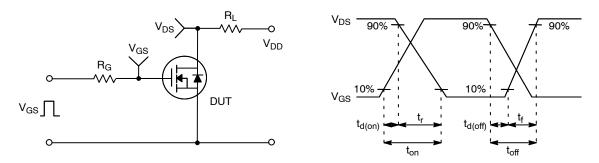
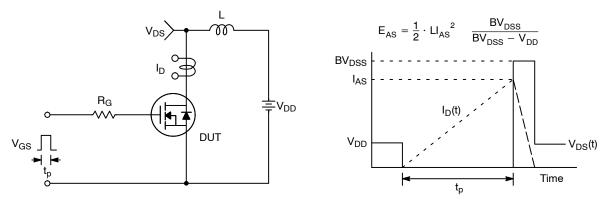


Figure 13. Resistive Switching Test Circuit & Waveforms





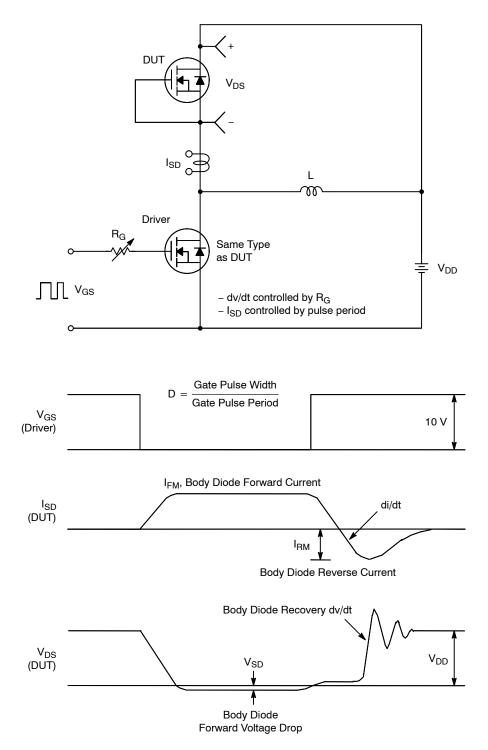
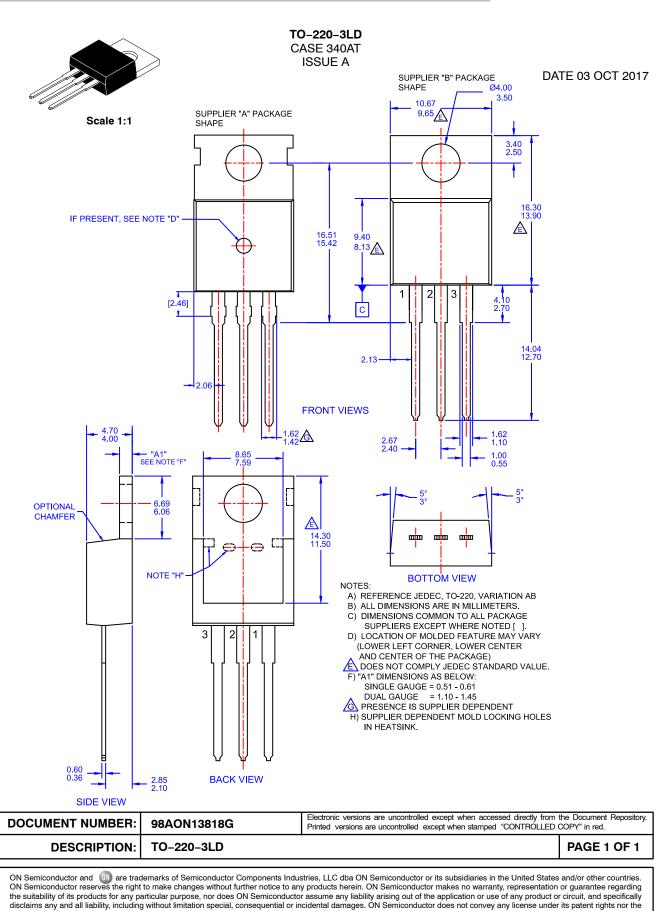


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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